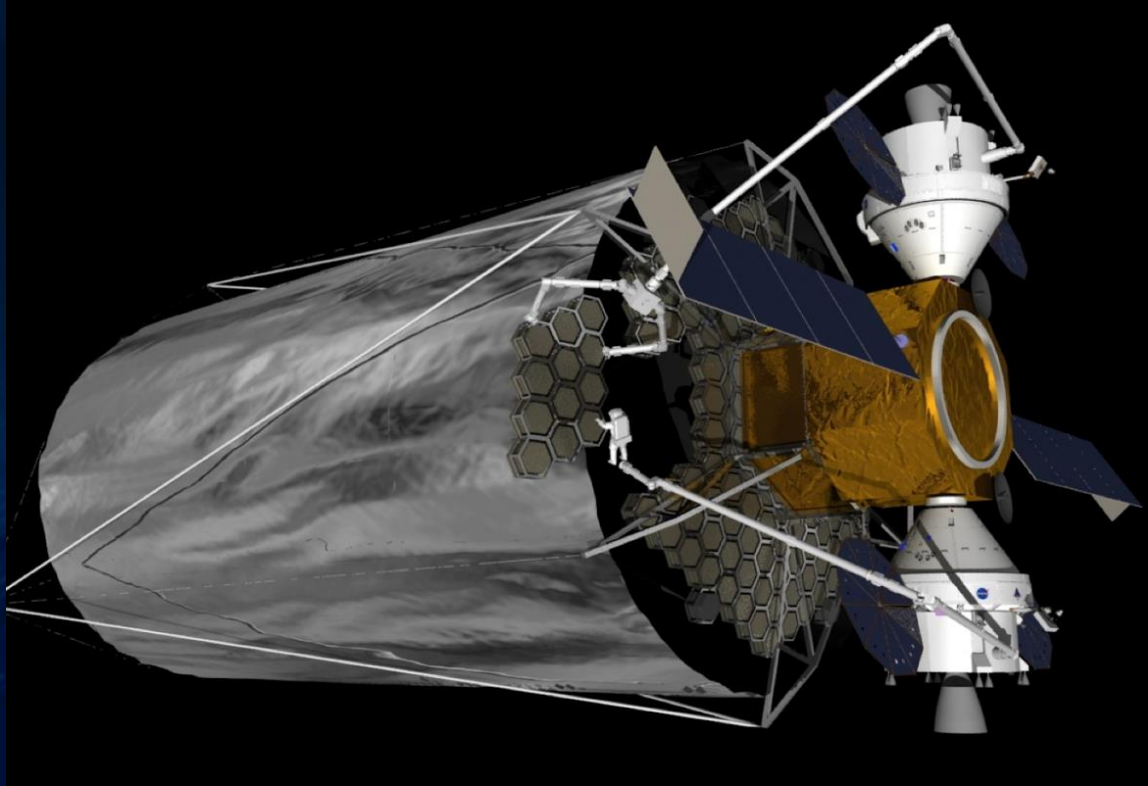


Matching NiP on Be-38Al for Low Temp Mirrors / SBIR Phase II



NASA MIRROR TECHNOLOGY DAYS
NOVEMBER 11, 2015 – ANNAPOLIS, MARYLAND
THE PEREGRINE FALCON CORPORATION

CURRENT SOA

Current state of the art materials for precision structures/optical substrates include:

- **ULE** – heavy & long lead time
- **SiC** – heavy & long lead time
- **Beryllium** – lightweight / high cost*
- **Composites** – lightweight / high cost

***JWST Beryllium Optics cost: \$6 M/m²**

The Candidate Material System will Provide...

- Large Monolithic Mirrors.
- Low Temperature Operation.
- High Stiffness/Stable.
- Durability / Robustness
- Budget Friendly Cost: 4x less than JWST



DEVELOPMENT: Be-38Al NEAR MATCHING CTE TO ELECTROLESS NICKEL

- Be-38Al
- Electroless Nickel – Phosphorous (NiP)
- Single Point Diamond Turn
- Use Liquid Interface Diffusion (LID) Bonding for joining to create large substrates/structures/Section Moduli.

*LOW COST APPROACH TO OPTICS
WHILE MAINTAINING OVER 80% OF
THE PERFORMANCE OF BERYLLIUM*

COMPARISON CHART (Ambient Temperature)

Property	Be-38Al AMS 7911	Beryllium	ULE	SiC
Density (g/cc)	2.10	1.85	2.21	2.89
Thermal Conductivity (W/mK)	210	216	1.3	155
CTE (ppm/°C)	13.9	11.4	< 1	2.4
Modulus of Elasticity (GPA)	192	303	68	330
Ductility (%)	2	2	Very Low	Very Low
Yield Strength (MPA)	192	241	< 50	NA
PEL (MPA)	17.3	30	NA	NA
Specific Heat (J/kg°K)	1506	1925	767	670
Specific Stiffness	91	164	30	114
Machinability (1 easy)	2.5*	6	8	10

Ductile

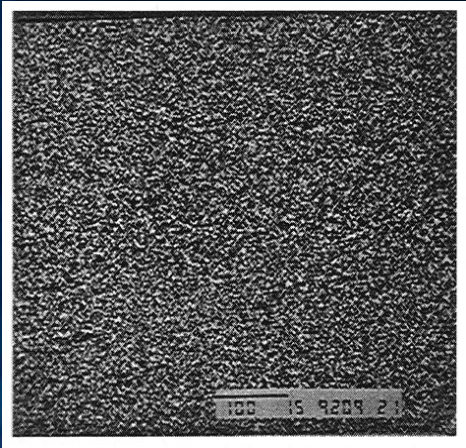
Large Sections

Producibility

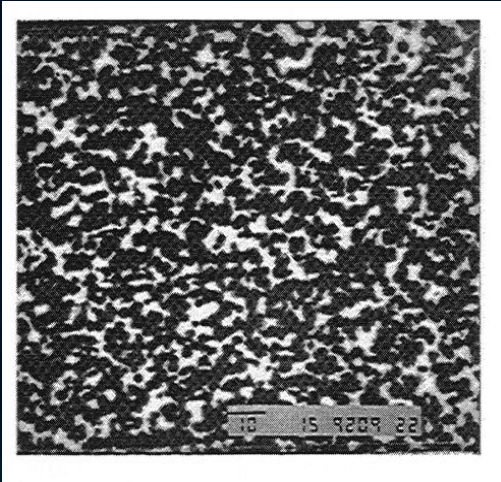
* Aluminum = 1

Be-38Al

(Highly Characterized Material – Re-Introduced in Early 1990's)



Low cost substitute for beryllium.
(Density 1.85 gm/cc Be; 2.1 gm/cc Be-38Al)

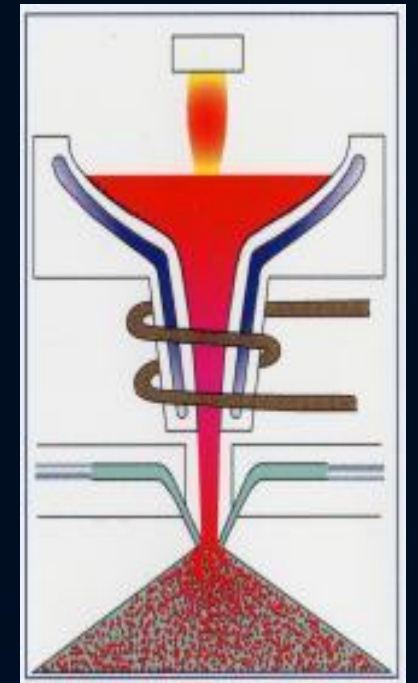
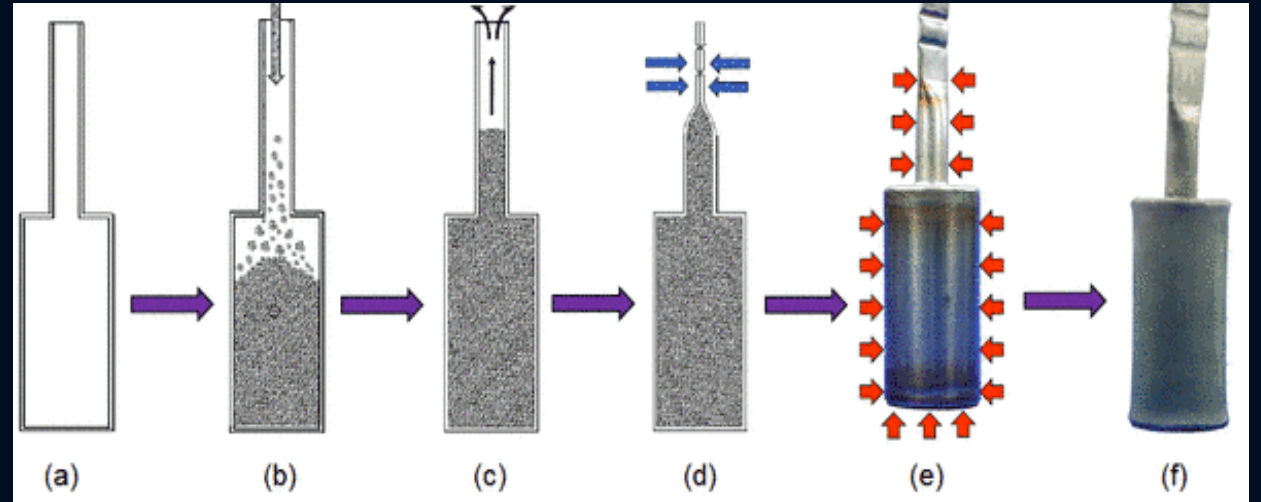


Beryllium is a brittle material, like other optical materials, which requires heavier wall thicknesses than what most designs specify.

Be-38Al has improved toughness allowing thinner wall sections to be fabricated, resulting in a substrate weight similar to beryllium.

Be-38Al

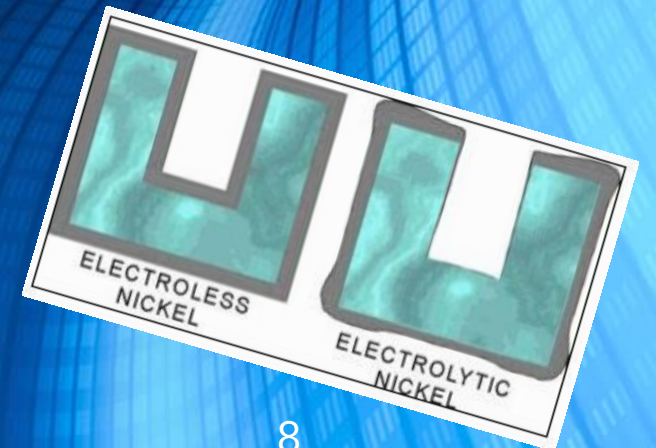
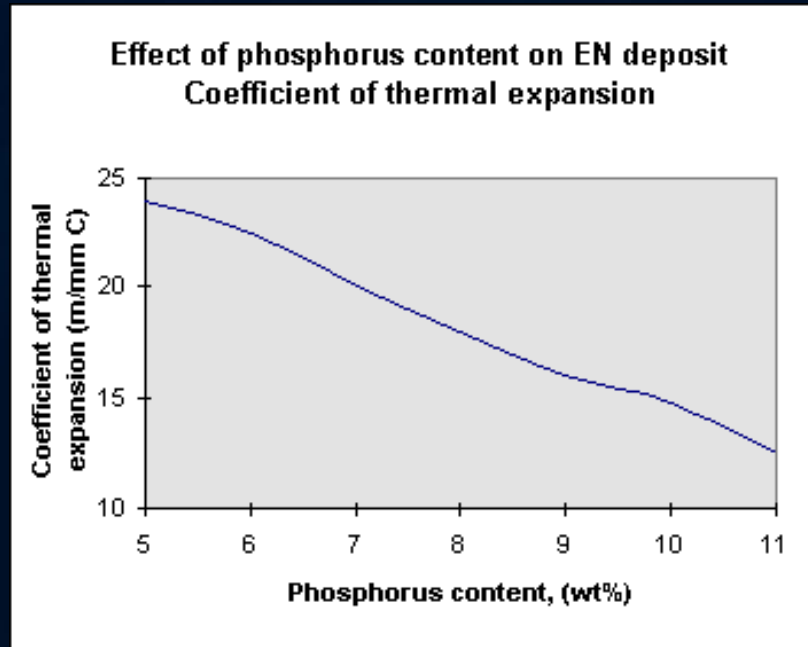
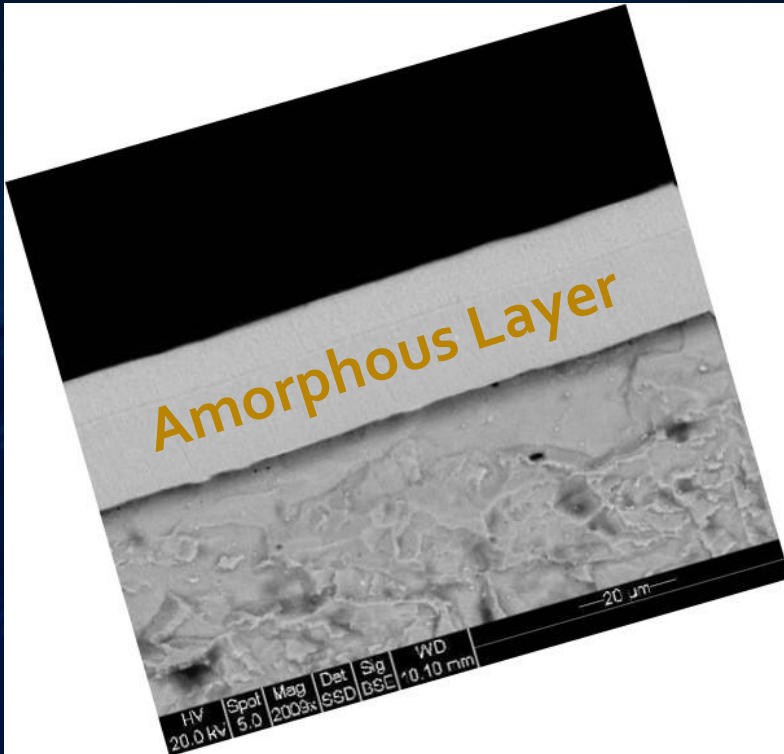
- 62% Be and 38% Al by weight; commercially pure materials as they are combined.
- < 2% Solution (Composite)
- Powder Metal made by gas atomization.
- Material follows the rule of mixtures for its properties.
- Hot Isostatically Pressed (HIP'd).

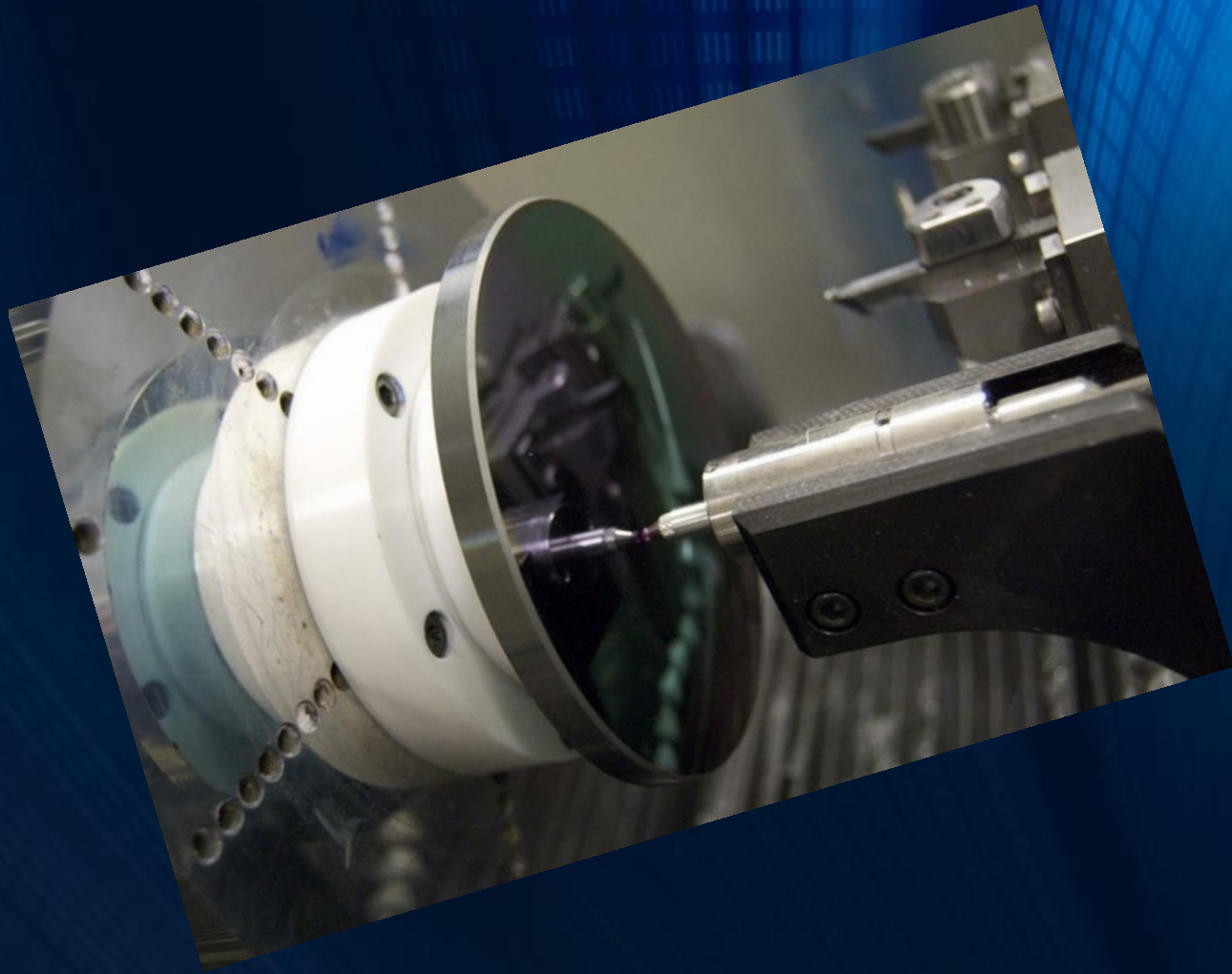


Electroless Nickel

(A Highly Characterized Process – Developed in 1942)

- An autocatalytic process that uniformly deposits and replicates the receiving surface.
- It is amorphous layer, leading to the term “metal glass.”
- Highly machinable.





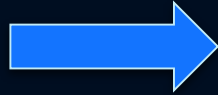
Single Point
Diamond Turning
of Amorphous NiP

Turned to the edge

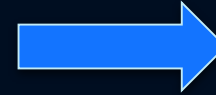
Be-38Al / NiP⁺ / SPDT

CHEMISTRY

Screen NiP
%P Range



Refine
Range

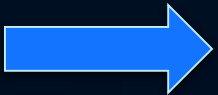


Define a
Working
Range

**MATCH CTE OF Be-38Al & NICKEL
ACROSS A DEFINED
OPERATING
TEMPERATURE
RANGE
(Goal Cryogenic)**

THICKNESS

Screen NiP
Thk Range



Understand Effect
of Thickness on
Performance over
Temperature
Range



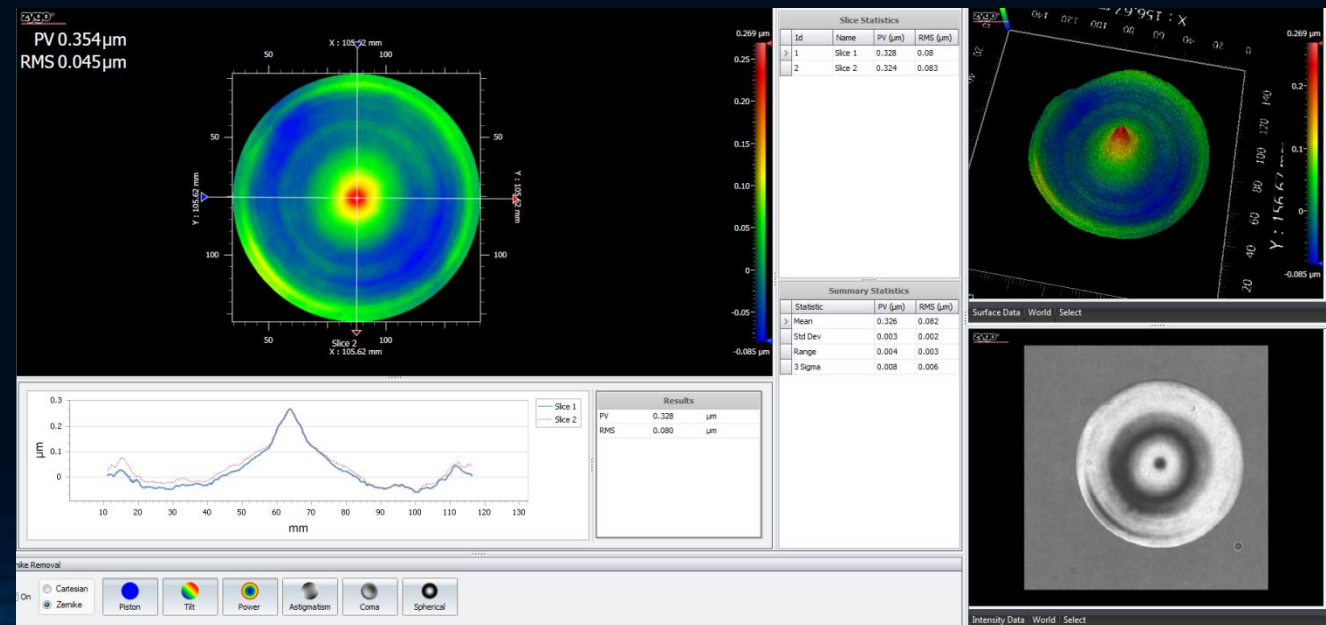
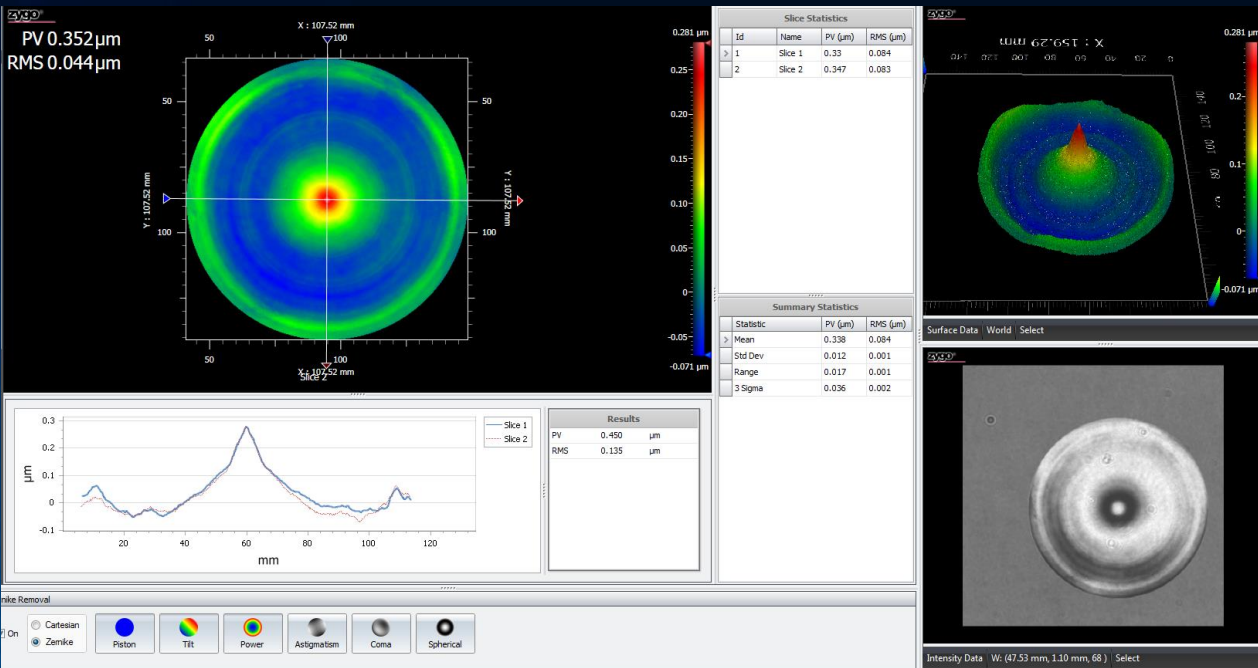
Be-38Al / NiP⁺ / SPDT

Post-Cryo Cycling
Measurements

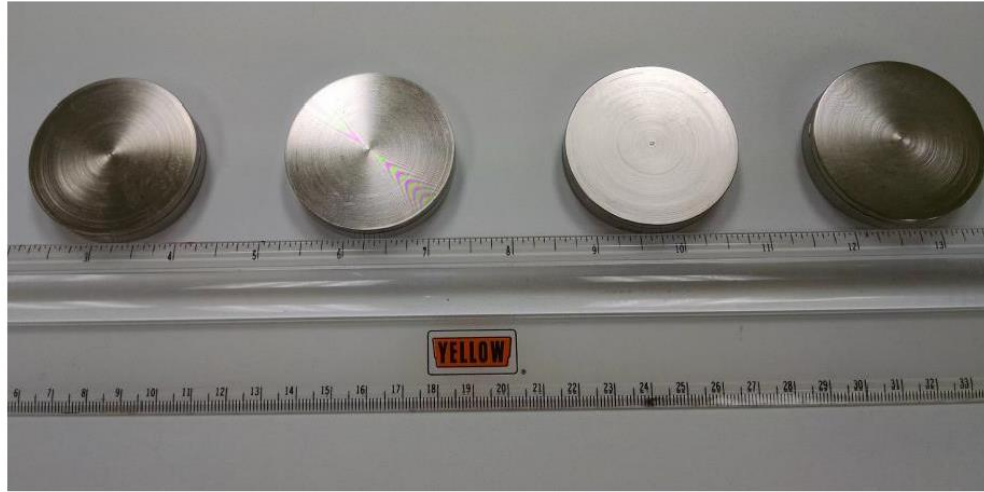
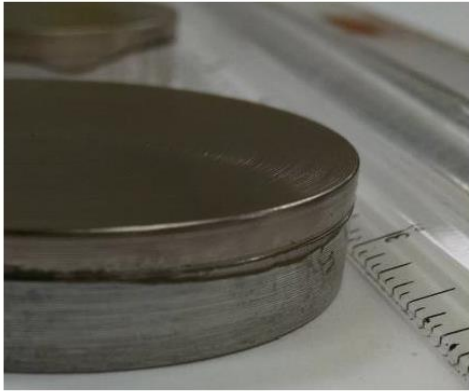


Pre-Cryo Cycling
Measurements

No Discernible Change after
Cryo Temperature Cycling



Be-38Al Current Efforts of Focus



Electroless Nickel Plating Coupons with Varied P%

Coupon	+/- P%
A*	-0.60
B*	-0.46
C*	-0.20
D*	-0.15
E*	-0.00
F*	+0.15
G*	+0.55

* From Phase I "sweet spot"

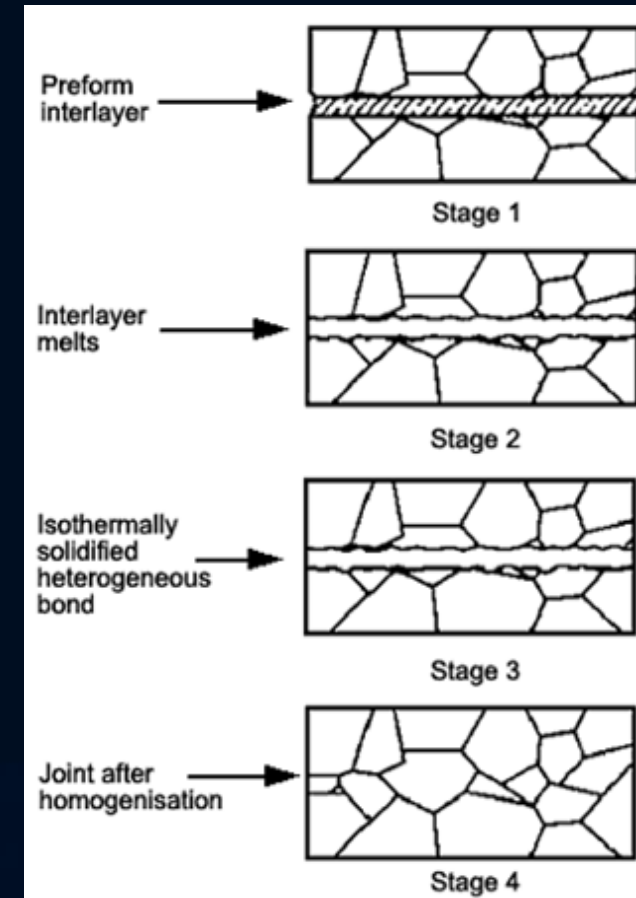
1. Dial in phosphorous percentage of electroless nickel to match Be-38Al.
2. Two campaigns of coupons underway; the first group finishing up in SPDT and the second group ready to NiP plate.

DEVELOPMENT: LID Bonding Be-38Al

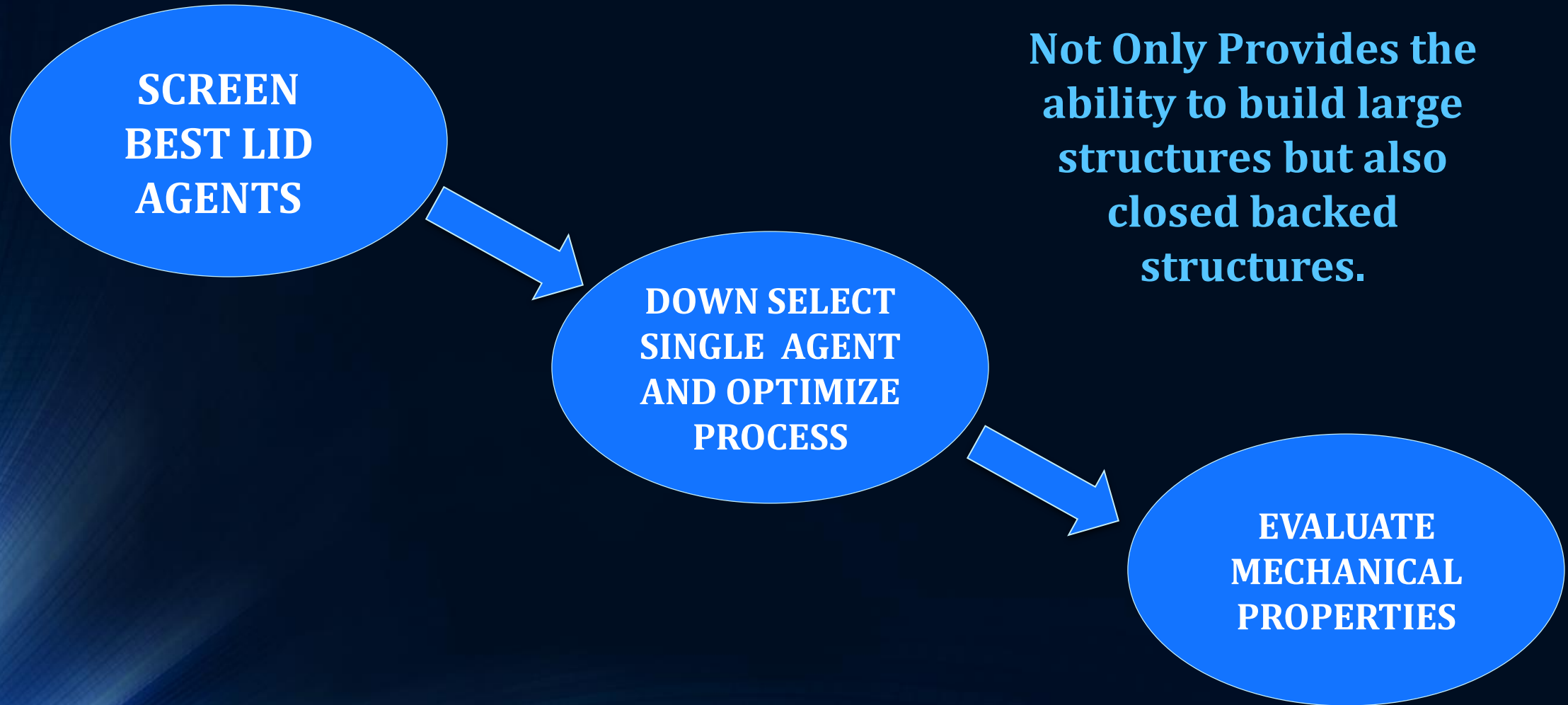
(LIQUID INTERFACE DIFFUSION BONDING)

- LID bonding relies upon temperature and pressure .
- The detail parts are stress relieved before metallurgical joining.
- A stabilization process follows to relieve any induced stress through the joining process.
- Process is step-able.

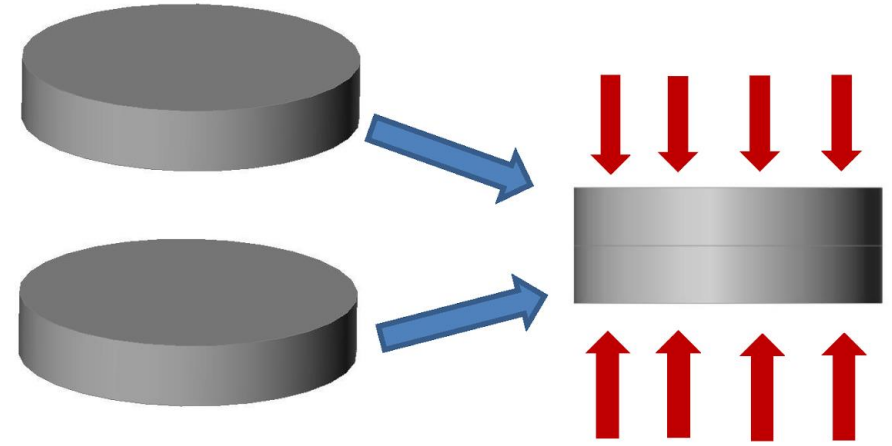
*Large Optics;
8 M Diameter*



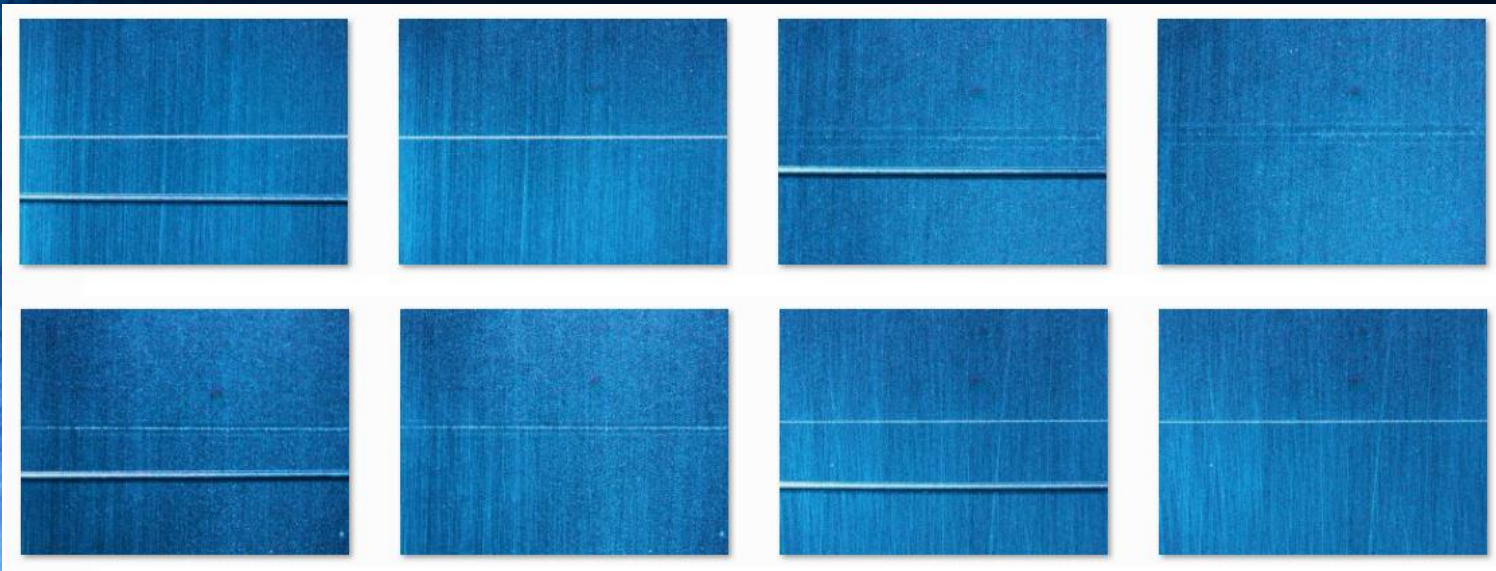
DEVELOPMENT: LID BONDING

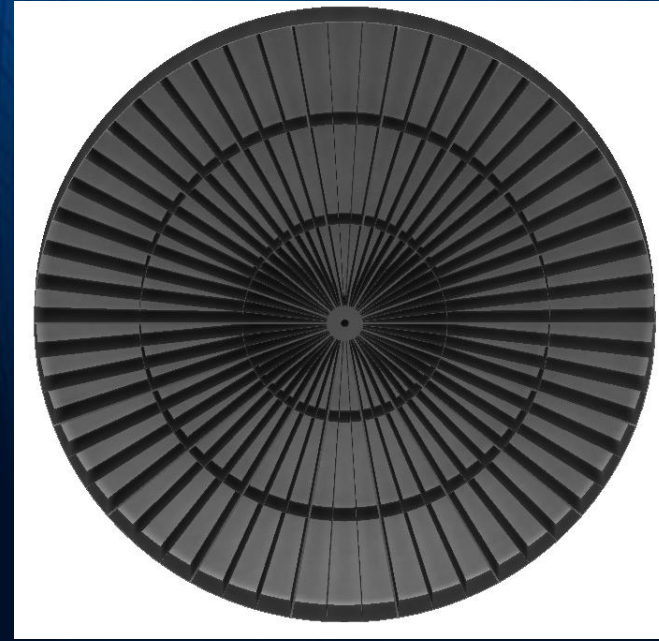
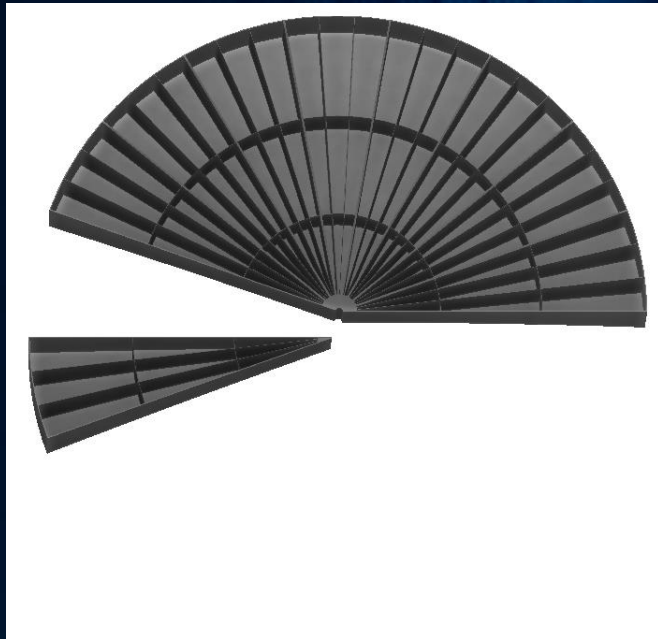
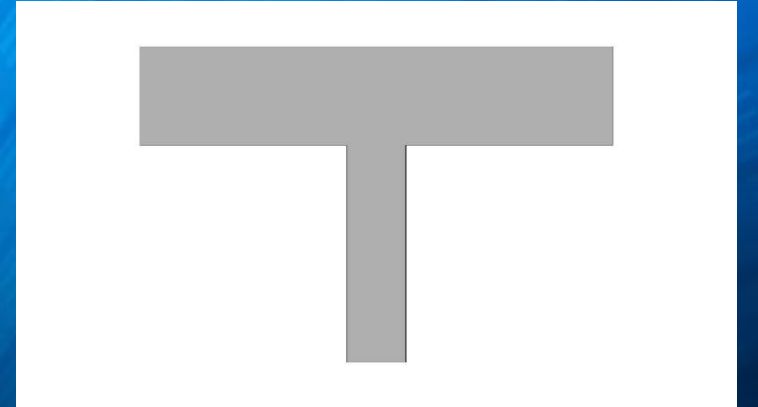
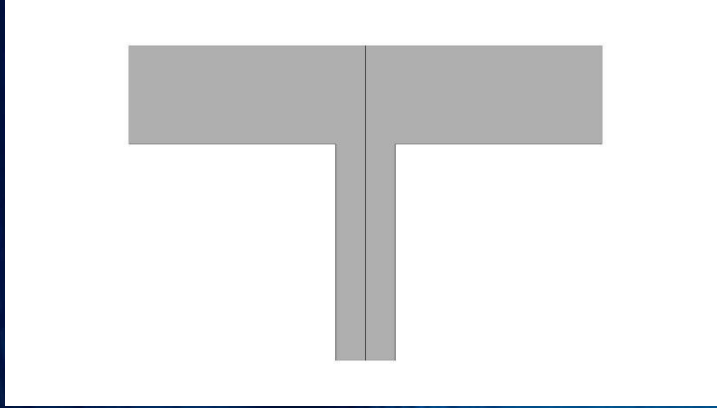
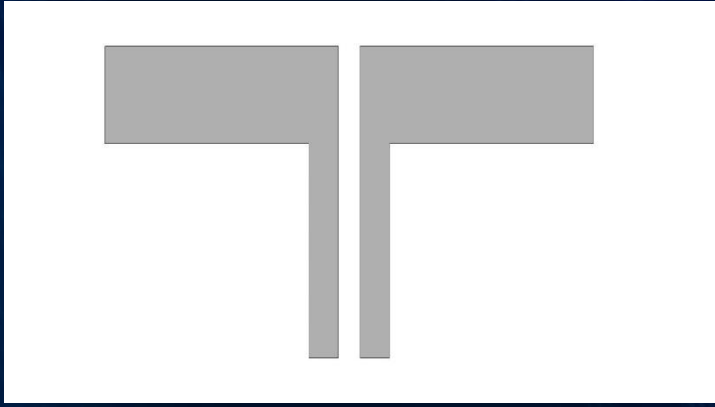


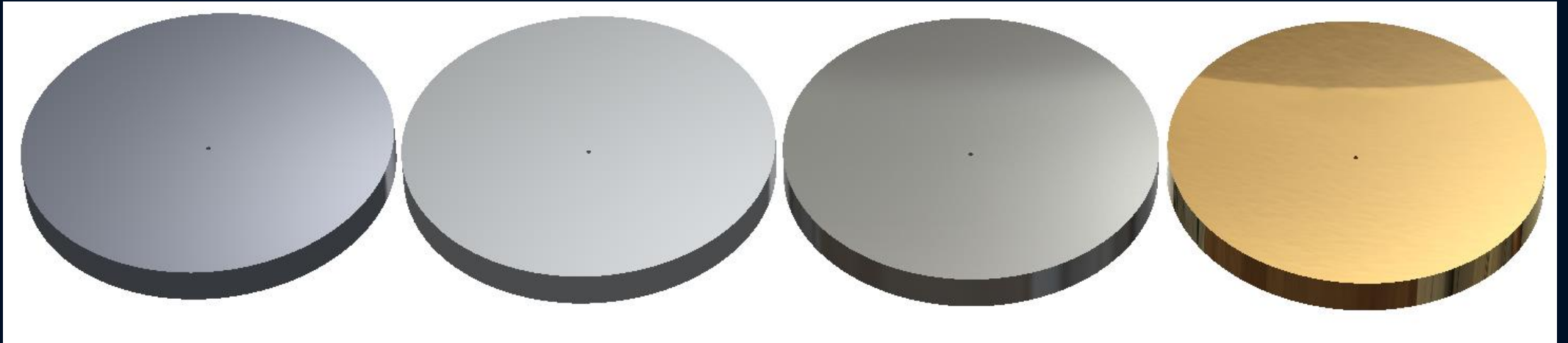
Liquid Interface Diffusion Bond Screening



Coupons Consolidated Under High Temperature and High Pressure







Advantages (Producibility):

The Be-38Al/NiP/SPDT system provides the following advantages:

- Large Mirrors at a cost $< 1.5\text{M}/\text{m}^2$ (and make large structures).
- Low Temperature Operation.
- Thick substrates can be produced (Aspect ratios < 10 to 1; Large section modulus).
- Low density, high stiffness and ductility allows for thin sections (Lightweight substrates to survive launch).
- NiP provides an amorphous optical surface (for SPDT).
- SPDT to the edge uses entire optical surface and eliminates stray light (More efficient).
- Robust; it's durable and repairable (You can manage a schedule).
- Provides the option for an athermal system.